P2806

SEAT No.:	
[Total	No. of Pages : 2

[5154]-188

B.E. (Computer Engineering) VLSI & DIGITAL SYSTEM DESIGN

(2008 Course) (Elective - IV) (Semester-II) (410451A)

Time: 3 Hours] [Max. Marks: 100] Instructions to the candidates: Answer Question No.1 OR 2,3 OR 4, and 5 OR 6 from Section I and Q. No.7 OR 8, 9 OR 10 and 11 OR 12 from Section II. Answers to the two Sections must be written in separate answer books. 2) Neat diagram must be drawn whenever necessary. Figures to the right indicate full marks. *5*) Assume suitable data, if necessary. **SECTION -I** Explain layout design rules for devices and interconnects. **Q1)** a) [9] Explain types of technology scaling. [8] b) OR Compare Speed-Power performance of available technologies. **Q2)** a) [9] Explain different tools for device simulation. [8] b) Explain fabrication of Cu interconnects with suitable diagram. *Q3*) a) [8] Describe different limiting performance of CMOS. [9] b) OR Explain Shallow Trench Isolation (STI) with process flow. **Q4)** a) [8] Explain the different process options for device isolation. [9] b) Explain wet etching and plasma etching. **Q5)** a) [8] Explain basic properties of Silicon Wafer. [4] b) Explain Czochrlski and Float-Zone Crystal growth methods. c) [4] OR **Q6)** a) Write a short note on: [8] i) Nano imprint Lithography. Electron-beam lithography. Explain Chemical vapor oxidation technique. **b**) [8]

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SECTION -II

Q 7)	a)	Explain Island style and Row based FPGA architectures in detail.	[8]	
	b)	Explain different Modelling styles in HDL.	[9]	
		OR		
Q8) a)		Explain following terms with examples:		
		i) Identifier		
		ii) Variable		
		iii) Array		
	b)	Draw state diagram and write VHDL Code for Traffic Light controller.	[8]	
Q9)	a)	Explain the types of programmable logic devices n detail.	[8]	
	b)	Explain Application Specific IC's Design flow.	[4]	
	c)	Explain role of interconnect in VLSI design.	[4]	
		OR		
Q10) a)		Explain static and dynamic behaviour of CMOS devices and circuits.[8]		
	b)	Explain role of software tools in digital design. Explain the types software tools in VLSI design.	of [8]	
Q11	<i>!)</i> a)	List out different steps for designing clocked synchronous machine.	[8]	
b)		Explain different design parameters for digital circuit design.	[5]	
	c) Explain merits and demerits of FPGA.		[4]	
		OR		
Q12) a)		Explain timing parameters for read and write operation in static RAM.[8]		
b)		For clock circuitry explain the following:	[9]	
		i) Clock skew		
		ii) Clock jitter		
		iii) Slew		
		$\otimes \otimes \otimes$		